### TOSHIBA

# MICROWAVE SEMICONDUCTOR TECHNICAL DATA

# MICROWAVE POWER GaAs FET TIM1213-5 PRELIMINARY

#### **FEATURES**

- **HIGH POWERT** 
  - P1dB=37.0dBm at 12.7GHz to 13.2GHz
- **HIGH GAIN**

G1dB=7.0dB at 12.7GHz to 13.2GHz

#### ■ BROAD BAND INTERNALLY MATCHED

■ HERMETICALLY SEALED PACKAGE

#### RF PERFORMANCE SPECIFICATIONS (Ta= 25°C)

CHARACTERISTICS	SYMBOL	CONDITION	UNIT	MIN.	TYP.	MAX.
Output Power at 1dB	P1dB		dBm	37.0	37.5	
Compression Point						
Power Gain at 1dB	G1dB	VDS= 9V	dB	6.0	7.0	
Compression Point		f= 12.7 to 13.2GHz				
Drain Current	IDS1		Α		2.0	2.5
Power Added Efficiency	ηadd		%	_	25	
Channel Temperature Rise	ΔTch	VDS X IDS X Rth(c-c)	°C	_		80

#### **ELECTRICAL CHARACTERISTICS (Ta=25°C)**

CHARACTERISTICS	SYMBOL	CONDITION	UNIT	MIN.	TYP.	MAX.
Transconductance	gm	VDS= 3V	mS	_	1400	
		IDS= 2.4A				
Pinch-off Voltage	VGSoff	VDS= 3V	V	-2.0	-3.5	-5.0
		IDS= 72mA				
Saturated Drain Current	IDSS	VDS= 3V	Α	_	5.0	5.7
		VGS= 0V				
Gate-Source Breakdown	VGSO	IGS= -72μA	V	-5		
Voltage						
Thermal Resistance	Rth(c-c)	Channel to Case	°C/W	_	3.0	3.7

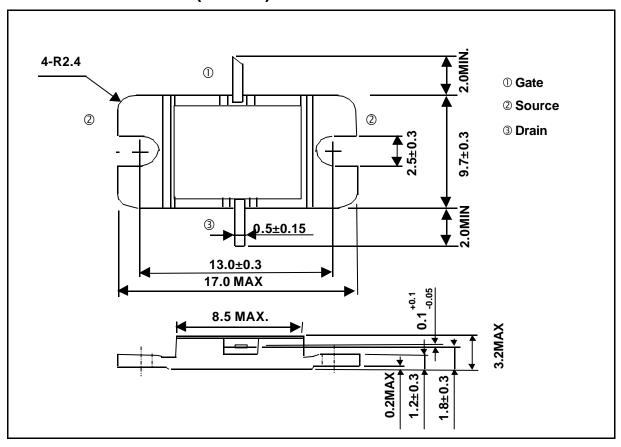
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# ABSOLUTE MAXIMUM RATINGS (Ta= 25°C)

CHARACTERISTICS	SYMBOL	UNIT	RATING
Drain-Source Voltage	VDS	V	15
Gate-Source Voltage	VGS	V	-5
Drain Current	IDS	Α	5.7
Total Power Dissipation (Tc= 25 °C)	PT	W	30
Channel Temperature	Tch	°C	175
Storage Temperature	Tstg	°C	-65 to +175

## PACKAGE OUTLINE (2-9D1B)



#### **HANDLING PRECAUTIONS FOR PACKAGED TYPE**

Soldering iron should be grounded and the operating time should not exceed 10 seconds at  $260^{\circ}$ C.